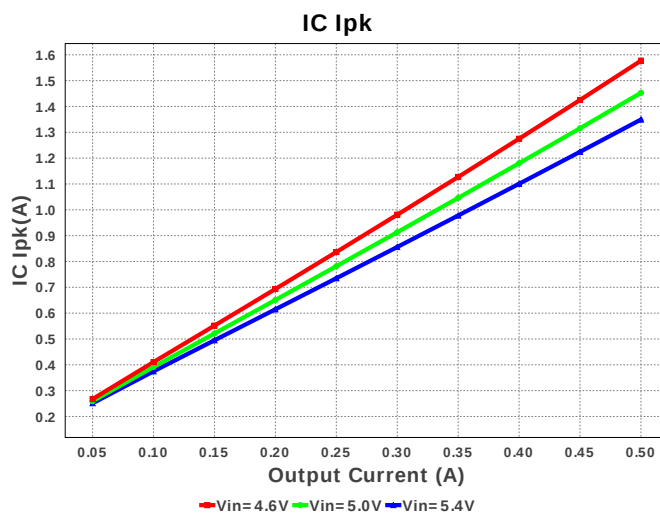
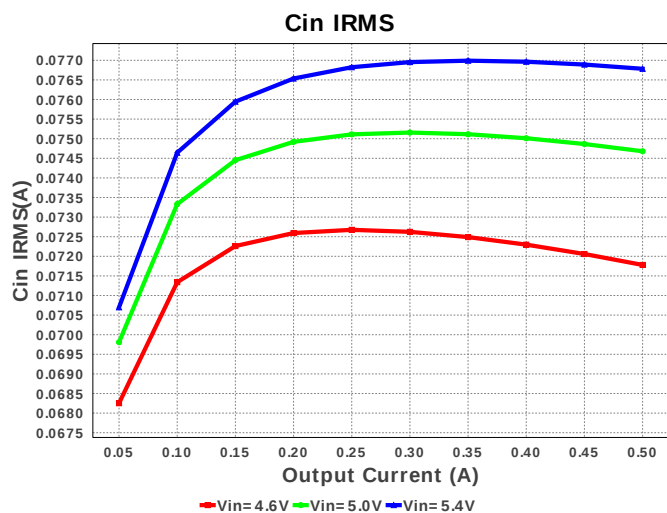
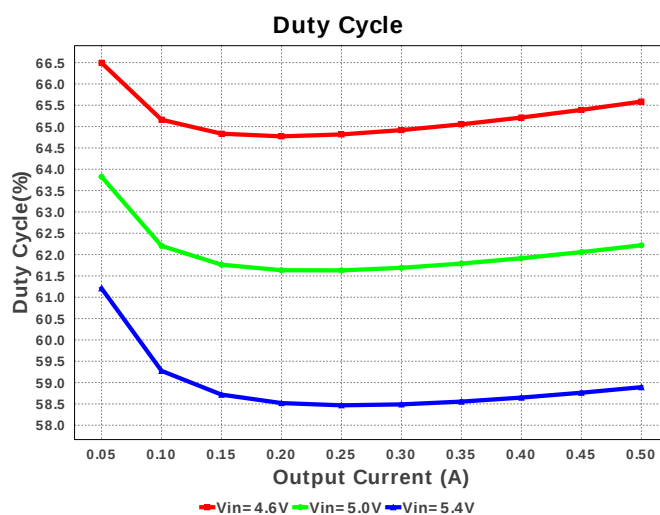
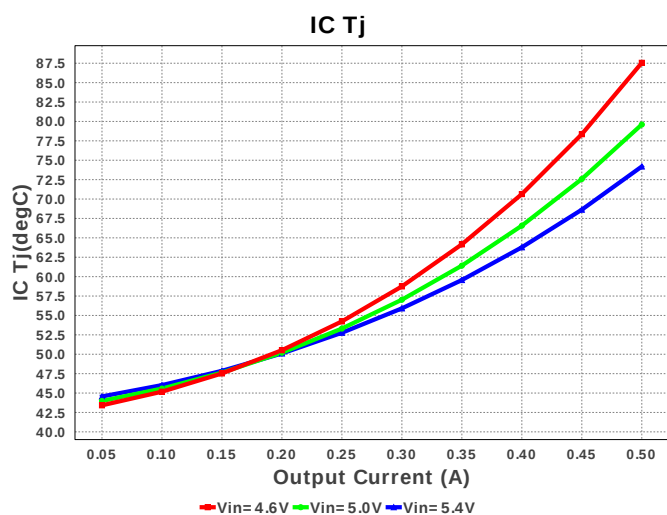
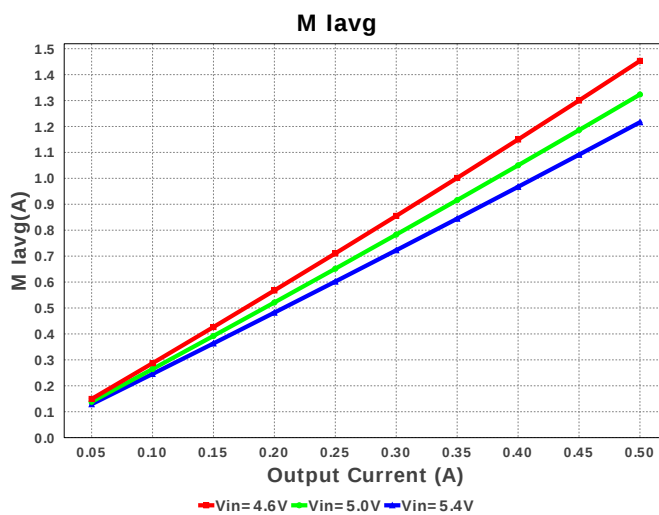
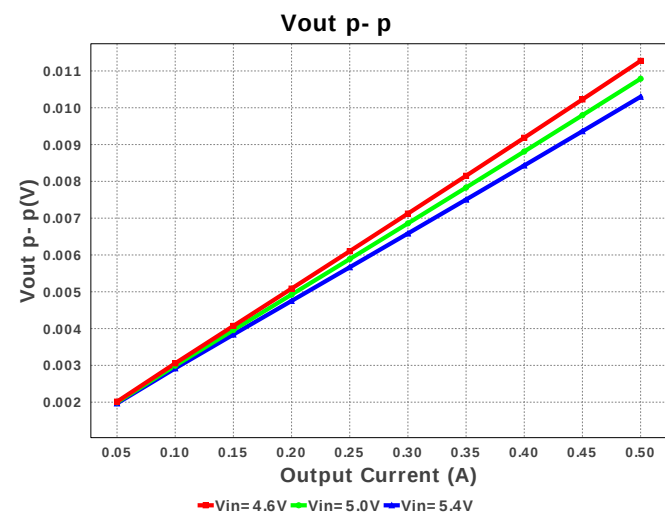
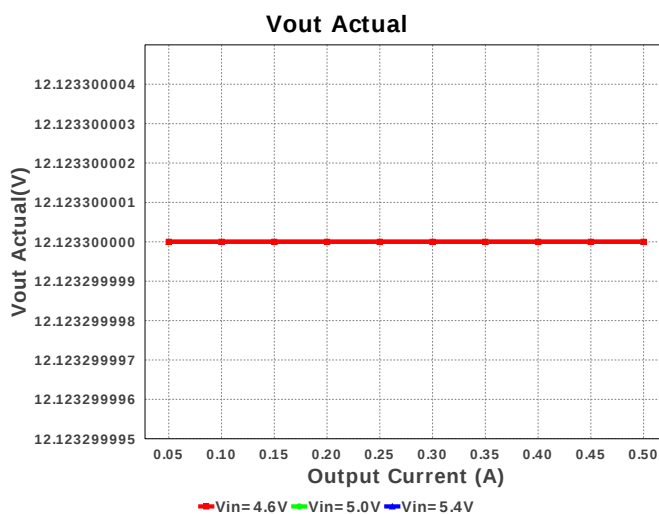
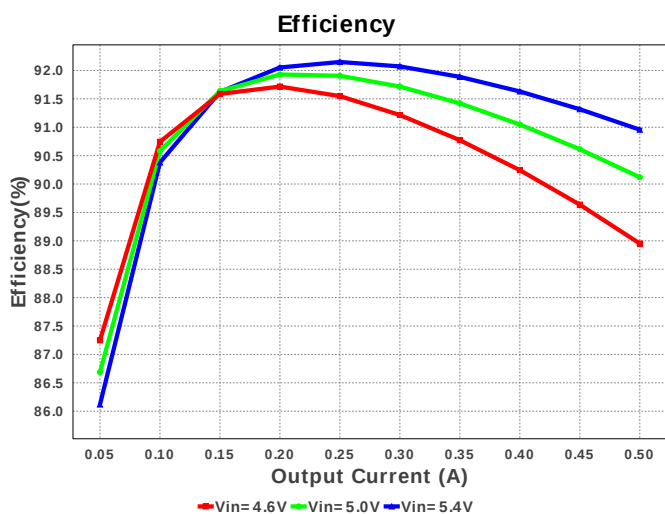
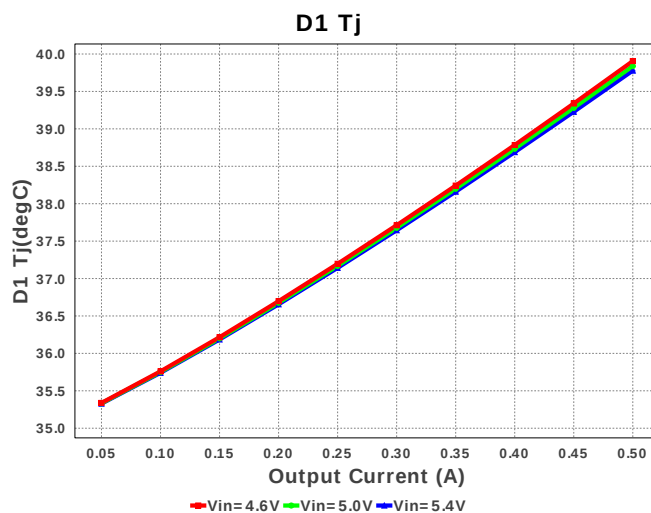
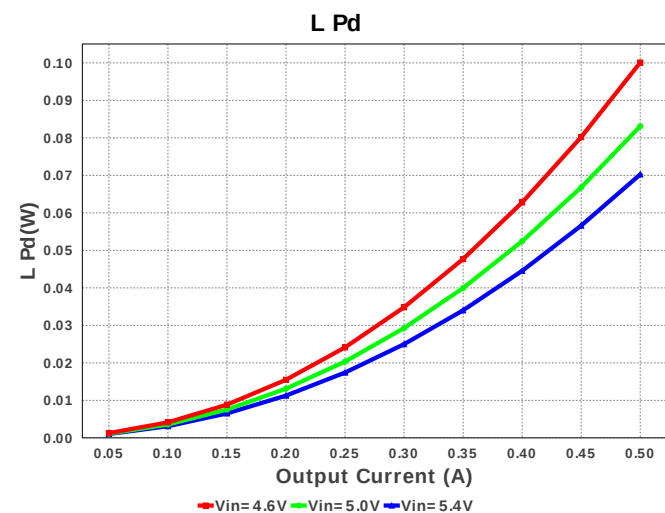


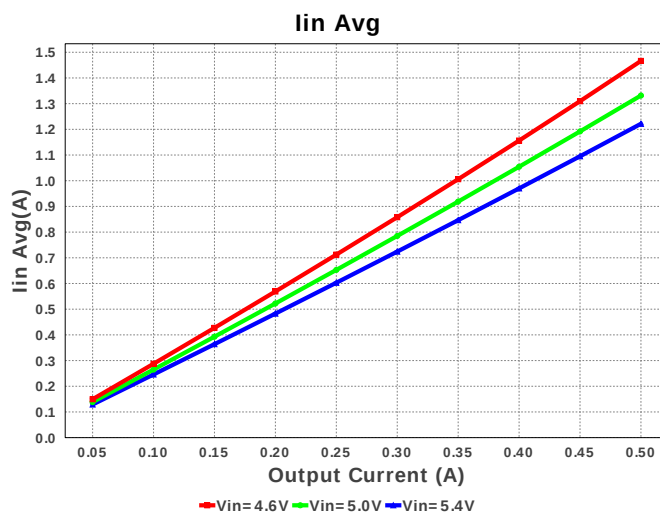
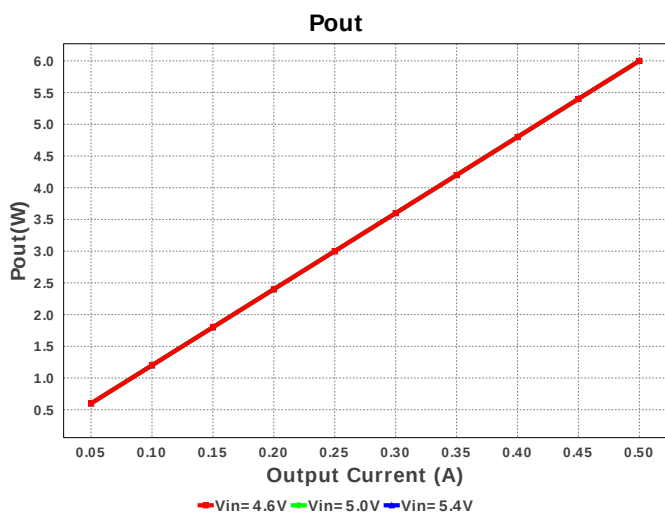
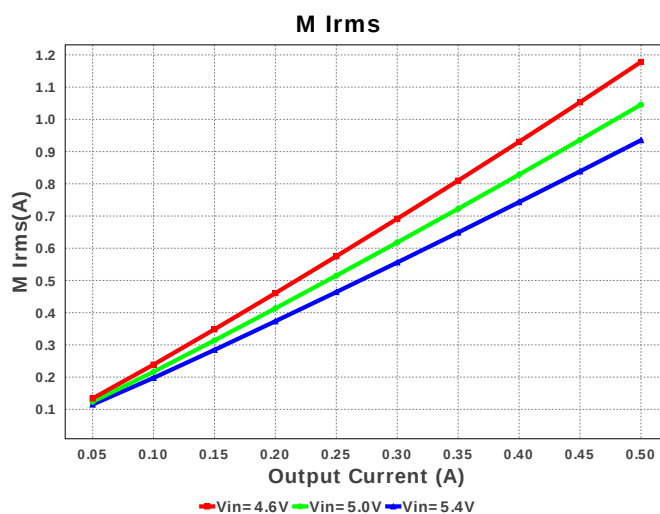
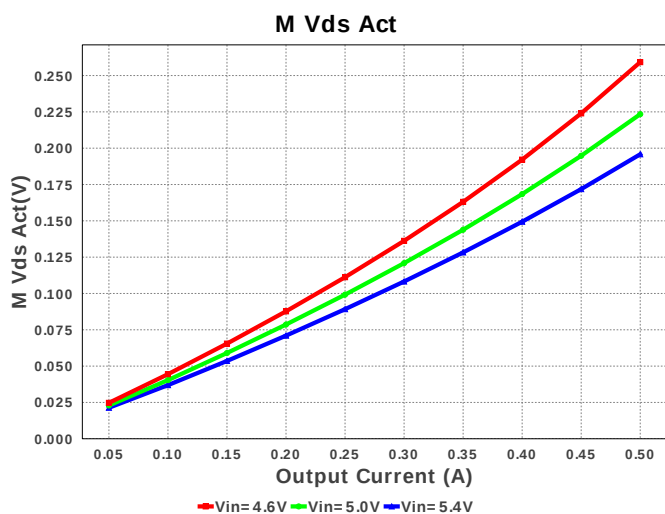
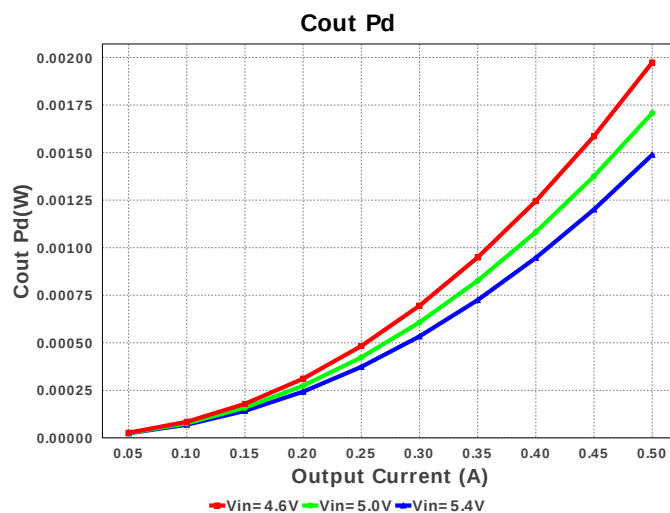
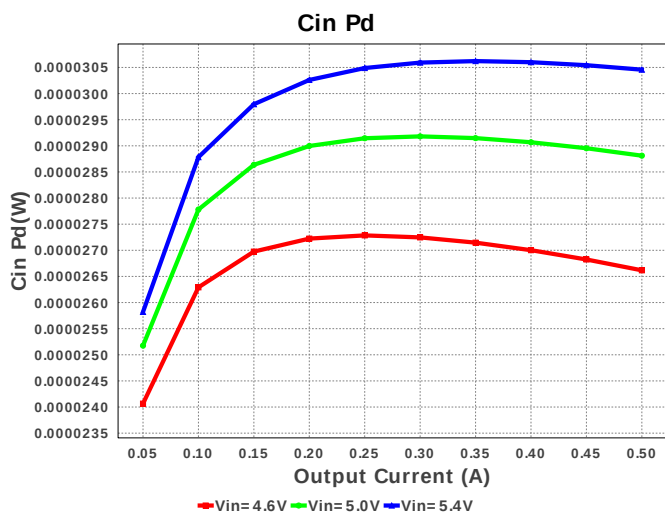


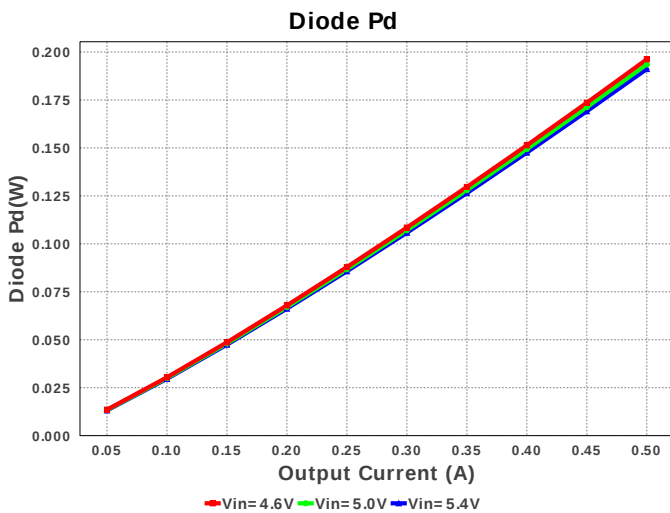
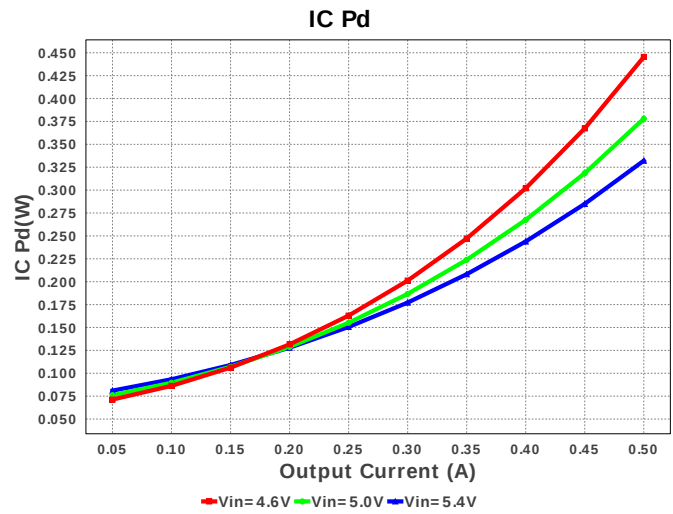
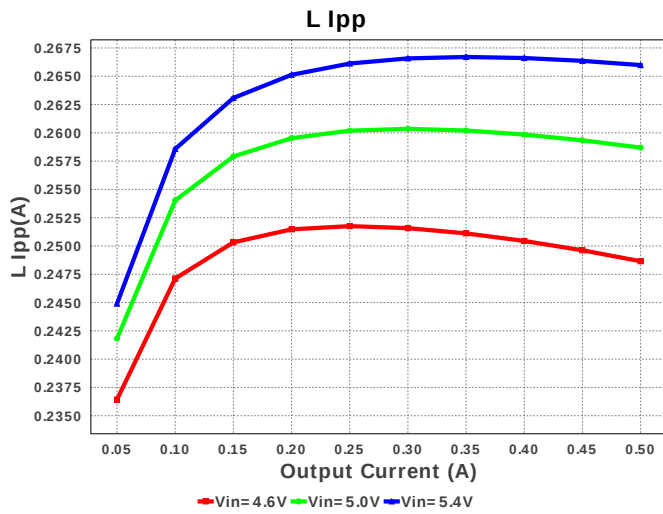
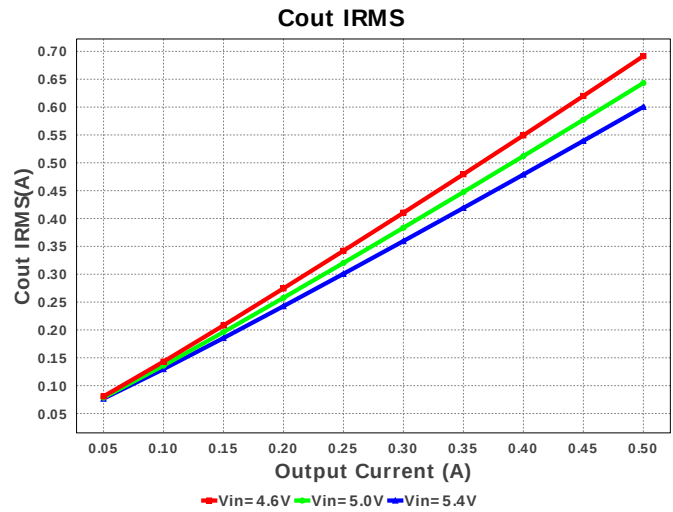
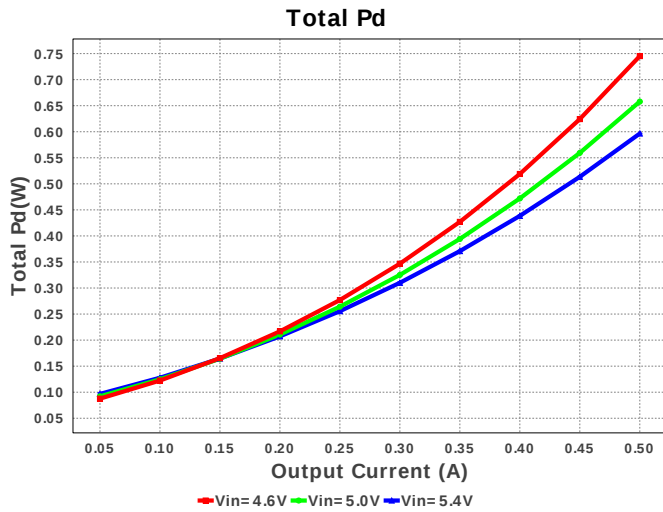
Device = LM2735XMF/NOPB
Topology = Boost
Created = 7/18/16 7:10:20 PM
BOM Cost = \$1.48
BOM Count = 9
Total Pd = 0.75W

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
9.	U1	Texas Instruments	LM2735XMF/NOPB	Switcher	1	\$1.15	 MF05A 15 mm ²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	71.78 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	691.536 mA	Current	Output capacitor RMS ripple current
3.	IC Ipk	1.577 A	Current	Peak switch current in IC
4.	Iin Avg	1.466 A	Current	Average input current
5.	L Ipp	248.65 mA	Current	Peak-to-peak inductor ripple current
6.	M Iavg	1.453 A	Current	MOSFET Average current
7.	M Irms	1.178 A	Current	MOSFET RMS current
8.	BOM Count	9	General	Total Design BOM count
9.	FootPrint	152.0 mm ²	General	Total Foot Print Area of BOM components
10.	Frequency	1.6 MHz	General	Switching frequency
11.	IC Tolerance	25.0 mV	General	IC Feedback Tolerance

#	Name	Value	Category	Description
12.	M Vds Act	259.227 mV	General	Voltage drop across the MosFET
13.	Pout	6.0 W	General	Total output power
14.	Total BOM	\$1.48	General	Total BOM Cost
15.	D1 Tj	39.905 degC	Op_Point	D1 junction temperature
16.	Vout Actual	12.123 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
17.	Vout OP	12.0 V	Op_Point	Operational Output Voltage
18.	Cross Freq	8.502 kHz	Op_point	Bode plot crossover frequency
19.	Duty Cycle	65.586 %	Op_point	Duty cycle
20.	Efficiency	88.952 %	Op_point	Steady state efficiency
21.	IC Tj	87.556 degC	Op_point	IC junction temperature
22.	ICThetaJA	118.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
23.	IOUT_OP	500.0 mA	Op_point	Iout operating point
24.	Phase Marg	86.336 deg	Op_point	Bode Plot Phase Margin
25.	VIN_OP	4.6 V	Op_point	Vin operating point
26.	Vout p-p	11.274 mV	Op_point	Peak-to-peak output ripple voltage
27.	Cin Pd	26.617 μW	Power	Input capacitor power dissipation
28.	Cout Pd	1.974 mW	Power	Output capacitor power dissipation
29.	Diode Pd	196.211 mW	Power	Diode power dissipation
30.	IC Pd	445.387 mW	Power	IC power dissipation
31.	L Pd	100.09 mW	Power	Inductor power dissipation
32.	Total Pd	745.185 mW	Power	Total Power Dissipation
33.	Vout Tolerance	3.839 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	500.0 m	Maximum Output Current
2.	VinMax	5.4	Maximum input voltage
3.	VinMin	4.6	Minimum input voltage
4.	Vout	12.0	Output Voltage
5.	base_pn	LM2735X	Texas Instruments Base Part Number
6.	source	DC	Input Source Type
7.	ta	35.0	Ambient temperature

Design Assistance

1. LM2735X Product Folder : <http://www.ti.com/product/LM2735> : contains the data sheet and other resources.

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